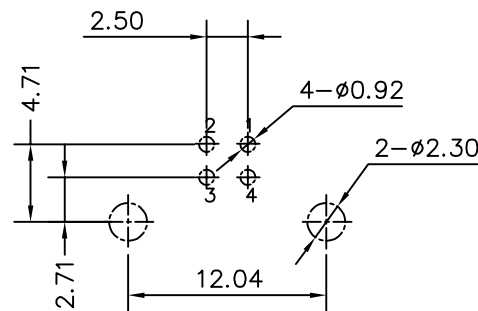
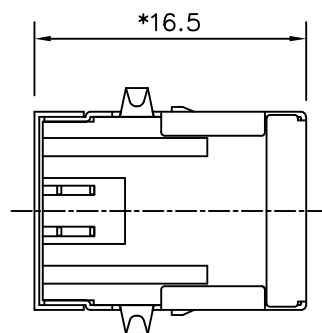
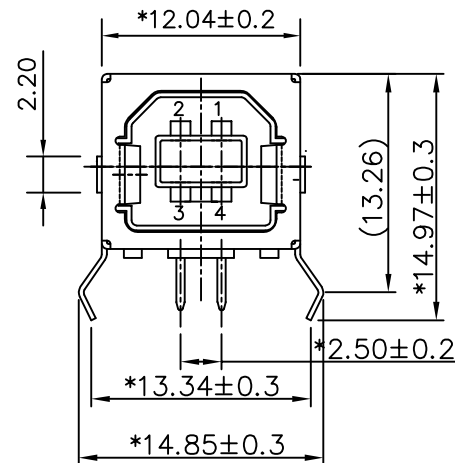
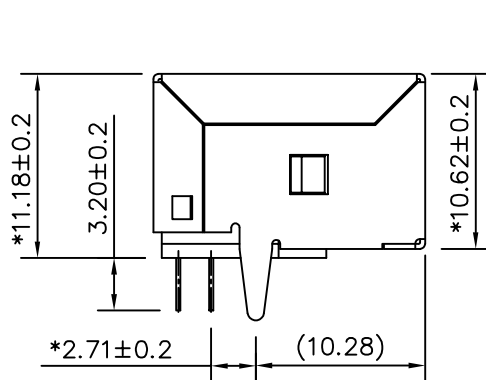


REVISION RECORD		
REV	DESCRIPTION	DRFT
11	OLD DRAWING CHECK IN	APFU 10/12/07
12	MODIFY DRAWING	Yuki 9/19/08
13	REASSIGN PIN NUMBER	Victor 27/03/12



USB-PCB LAYOUT

NOTES:

- MATERIAL:**
TERMINAL—C5191 PHOSPHOR BRONZE HARD.
SHIELD—COPPER ALLOY
HOUSING—PBT+30% G.F. UL94V-0
- PLATING:** CONTACT—GOLD PLATING OVER NICKEL
TERMINAL—75u" Tin MIN OVER 50u"—100u" NICKEL Δ
SHIELD—120u" TIN MIN OVER 50u" NICKEL.
OR 100u"~120u" NICKEL OVER 40u" Cu.
- GAP:** 0.25mm (Max.)
- ELECTRICAL:**
VOLTAGE RATING : 30 VAC RMS.
CURRENT RATING : 1.0 AMP
CONTACT RESISTANCE : 30 MILLIOHMS MAX
INSULATION RESISTANCE : 1000 MEGOHMS MIN @500 VDC
DIELECTRIC STRENGTH : 750 VAC RMS 60 HZ, 1 MIN
OPERATING LIFE : 1500 CYCLES MIN
MATING FORCE : 3.5 KGS MAX
UNMATING FORCE : 1 KGS MIN
- ENVIRONMENTAL:**
STORAGE : -40°C TO +85°C
OPERATION : -40°C TO +85°C
CAPACITANCE : 2 PF MAX 1KHZ
WAVE SOLDER TEMPERATURE: 230-250°C.(3-5 SECONDS)
RoHS COMPLIANT
- UL & CUL FILE NO.** E163191

OLD DRAWING NUMBER:GE813A02-LC

ROHS P/N	REV	MATERIAL	SHIELD PLATING	PLATING
E8144-B01321-L	A	PBT WHITE	PLATING NICKEL	Au3u"

DETACHED LISTS			DFTO SAMMY	DATE 03/14/05		RoHS Compliant		
	TOLERANCES EXCEPT AS NOTED		CHKD ALICE	DATE 3/29/2012				
	MM		APPVLTIM	DATE 3/29/2012	TITLE USB Series B 4-Position Dip Type			
	.0 ± 0.20	±	MATERIAL :					
	.00 ± 0.15	±	QT'Y :		DRAWING NO. E8144-B0XX2X-L2		SIZE	REV
	.000 ± 0.075	±	FINISH :		/PART NO. E8144-B0XX2X-L2		A3	13
	ANGLES ± 0.5°		SCALE : 3:1		DO NOT SCALE DRAWING		SHEET 1	OF 1